

1-channel High Side Switch

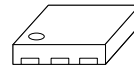
■ GENERAL DESCRIPTION

The NJW4832 is the single high-side switch that can supply 0.2A. The active clamp circuit, overcurrent and thermal shutdown are built-in to Pch MOS FET.

A logic signal (3V/5V) can be input directly. Especially, the NJW4832 is suitable for various Sensors output block as PNP type. The FLT logic has two versions: Active-high (A-ver) and Active-low (B-ver).

Also, The NJW4832 is a complementary product to the NJW4822.

■ PACKAGE OUTLINE

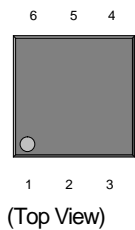


NJW4832KH1

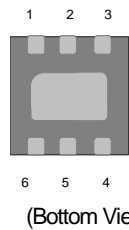
■ FEATURES

- Drain-Source Voltage 45V
- Output Current 0.2A
- Corresponding with Logic Voltage Operation: 3V/5V
- Low On-Resistance 0.75Ω (typ.)
- Low Consumption Current 110μA (typ.)
- Active Clamp Circuit
- Over Current Protection (Self recovery type current limiting function)
- Thermal Shutdown
- Package Outline DFN6-H1 (ESON6-H1)

■ PIN CONFIGURATION

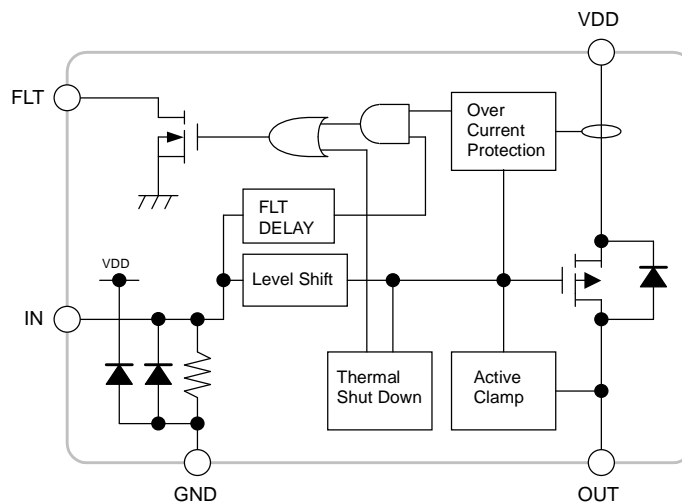


1. VDD
2. NC
3. OUT
4. IN
5. GND
6. FLT



Exposed PAD on backside connect to GND.

■ BLOCK DIAGRAM



NJW4832

■ ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

PARAMETER	SYMBOL	RATINGS	UNIT	REMARK
Drain-Source Voltage	V_{DS}	45	V	VDD-OUT Pin
Supply Voltage	V_{DD}	45	V	VDD-GND Pin
Input Pin Voltage	V_{IN}	-0.3 to +6	V	IN-GND Pin
FLT Pin Voltage	V_{FLT}	-0.3 to +6	V	FLT-GND Pin
Power Dissipation	P_D	445 (*1) 1135 (*2)	mW	-
Active Clamp Tolerance (Single Pulse)	E_{AS}	100	mJ	-
Active Clamp Current	I_{AP}	0.2	A	-
Junction Temperature	T_j	-40 to +150	°C	-
Operating Temperature	T_{opr}	-40 to +125	°C	-
Storage Temperature	T_{stg}	-50 to +150	°C	-

(*1): Mounted on glass epoxy board (101.5×114.5×1.6mm: based on EIA/JEDEC standard, 2Layers FR-4, with Exposed Pad)

(*2): Mounted on glass epoxy board (101.5×114.5×1.6mm: based on EIA/JEDEC standard, 4Layers FR-4, with Exposed Pad)
(4Layers: Applying 99.5×99.5mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5)

■ RECOMMENDED OPERATING CONDITIONS

(Ta=25°C)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	REMARK
Drain-Source Voltage	V_{DS}	0	-	40	V	VDD-OUT Pin
Supply Voltage	V_{DD}	4.6	-	40	V	VDD-GND Pin
Output Current	I_O	0	-	0.2	A	VDD-OUT Pin
Input Pin Voltage	V_{IN}	0	-	5.5	V	IN-GND Pin
FLT Pin Voltage	V_{FLT}	0	-	5.5	V	FLT-GND Pin

■ PRODUCT VERSION

PRODUCT NAME	FLT LOGIC
NJW4832KH1-A	Active High
NJW4832KH1-B	Active Low

■ ELECTRICAL CHARACTERISTICS

(Unless otherwise noted, $V_{DS}=13V$, $T_a=25^{\circ}C$)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain-Source Clamp Voltage	V_{DSS_CL}	$V_{IN}=0V$, $I_O=1mA$, $V_{DD}=40V$	$V_{DD}-45$	–	–	V
High Level Input Voltage	V_{IH}	$I_O=10mA$	2.64	–	–	V
Low Level Input Voltage	V_{IL}	$I_O=100\mu A$	–	–	0.9	V
Protection Circuit Function Input Voltage Range	V_{IN_opr}		2.64	–	5.5	V
OUT Pin Leak Current at OFF State	$I_{OLEAKOUT}$	$V_{IN}=0V$, $V_{DD}=40V$	–	–	1	μA
Quiscent Current 1	I_{DD1}	$V_{IN}=0V$, $V_{DD}=40V$	–	–	1	μA
Quiscent Current 2	I_{DD2}	$V_{IN}=5V$	–	110	150	μA
Input Current	I_{IN}	$V_{IN}=5V$	–	150	190	μA
On-State Resistance	R_{DS_ON}	$V_{IN}=5V$, $I_O=0.2A$	–	0.75	1.2	Ω
Over Current Protection	I_{LIMIT}	$V_{IN}=5V$, $V_{DS}=5V$	0.2	0.4	0.8	A
Turn-on Time	t_{ON}	$V_{IN}=0$ to $5V$, $I_O=0.2A$	–	10	–	μs
Turn-off Time	t_{OFF}	$V_{IN}=5$ to $0V$, $I_O=0.2A$	–	10	–	μs
OUT–VDD Voltage Difference	V_{PDOV}	$V_{IN}=0V$, $I_{ORH}=0.2A$	–	0.85	1.2	V
FLT Pin Low Level Output Voltage	V_{VFLT}	$I_{FLT}=500\mu A$	–	0.25	0.5	V
FLT Pin Leak Current at OFF State	$I_{OLEAKFLT}$	$V_{FLT}=5.5V$	–	–	1	μA
FLT Delay Time	t_{DFLT}	$V_{IN}=0$ to $5V$	–	5	–	ms

NJW4832

■ TRUTH TABLE

[A-version: Active-high]

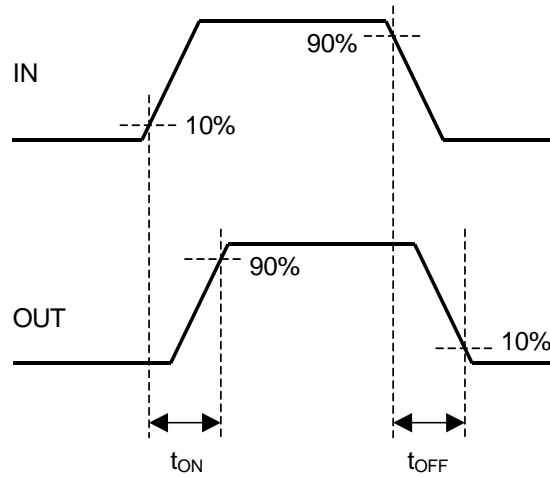
Input Signal	Operating Condition	FLT Pin	Output Status
L	Normal	H	OFF
H		L	ON
L	Over Current I_{LIMIT}	H	OFF
H		H	I_{LIMIT}
L	$T_j > 150^\circ\text{C}$	H	OFF
H		H	OFF

[B-version: Active-low]

Input Signal	Operating Condition	FLT Pin	Output Status
L	Normal	H	OFF
H		H	ON
L	Over Current I_{LIMIT}	H	OFF
H		L	I_{LIMIT}
L	$T_j > 150^\circ\text{C}$	H	OFF
H		L	OFF

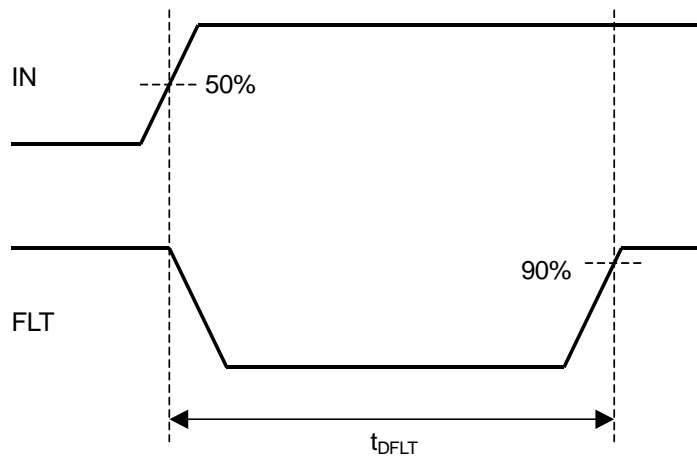
■ TIMING CHART

ON, OFF Switching Time ($V_{IN}=0$ to $5V$, $V_{DD}=13V$, $I_O=0.2A$)

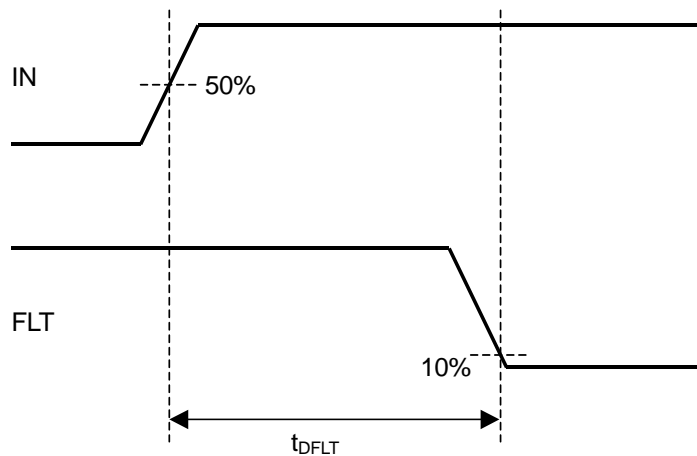


FLT Delay Time ($V_{IN}=0$ to $5V$, $V_{DD}=V_{DS}=13V$, FLT=Pull-up, OUT-GND shorting)

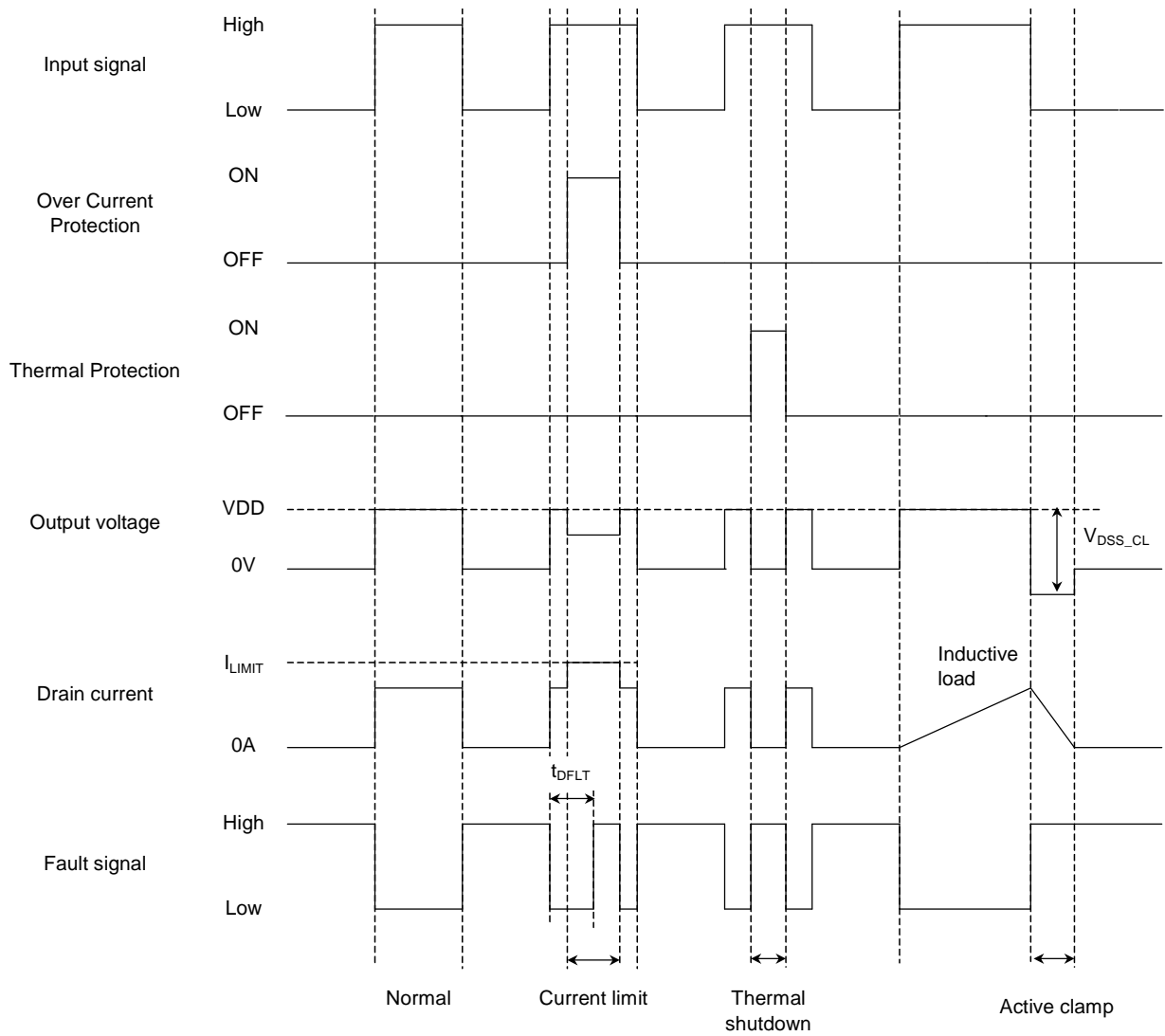
[A-version: Active-high]



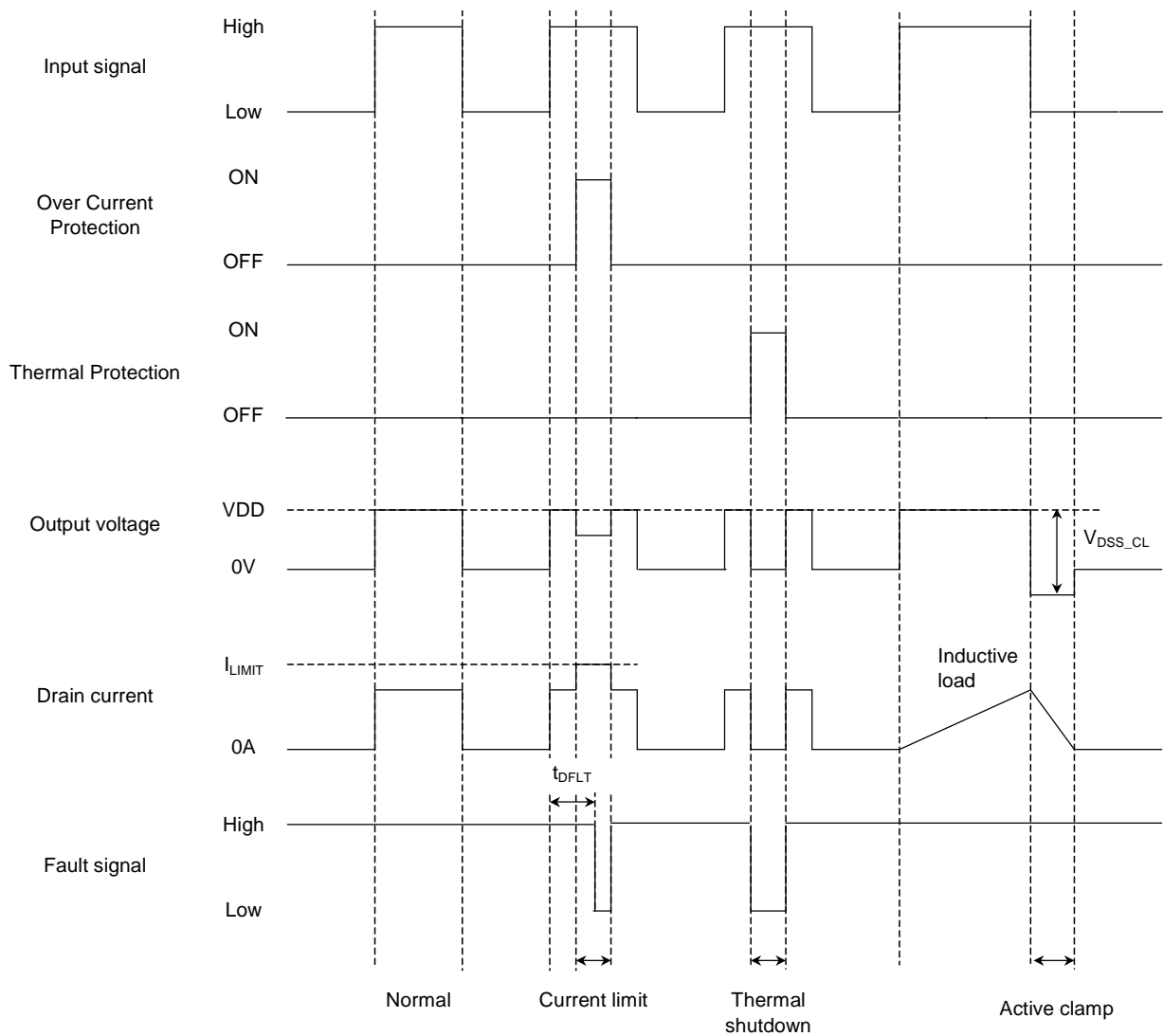
[B-version: Active-low]



[A-version: Active-high]

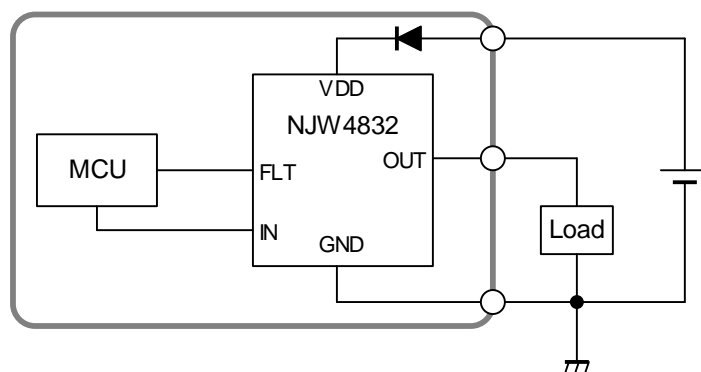


[B-version: Active-low]



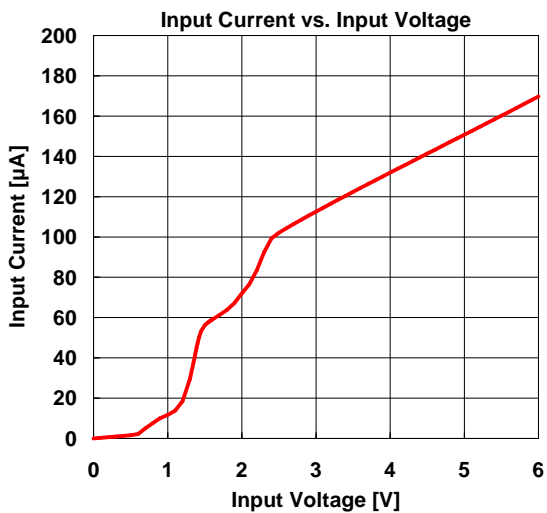
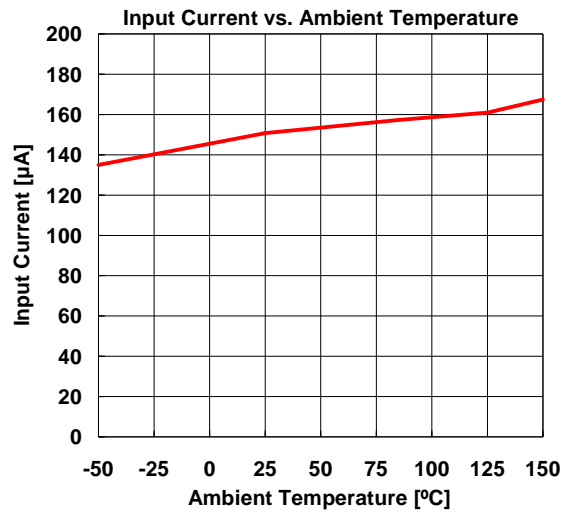
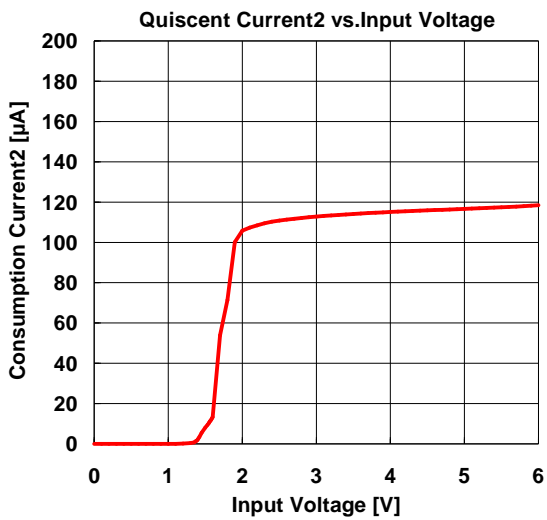
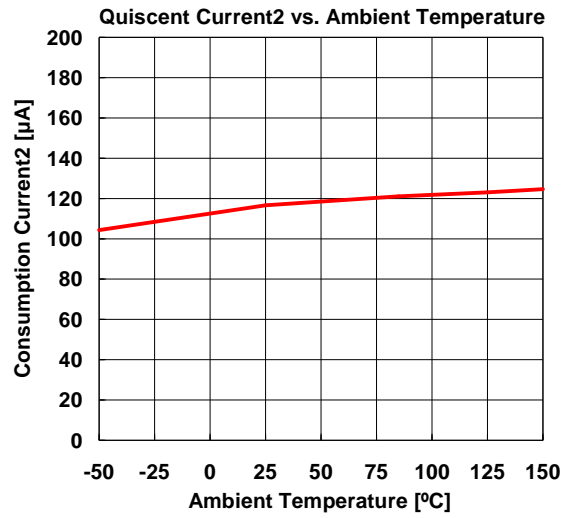
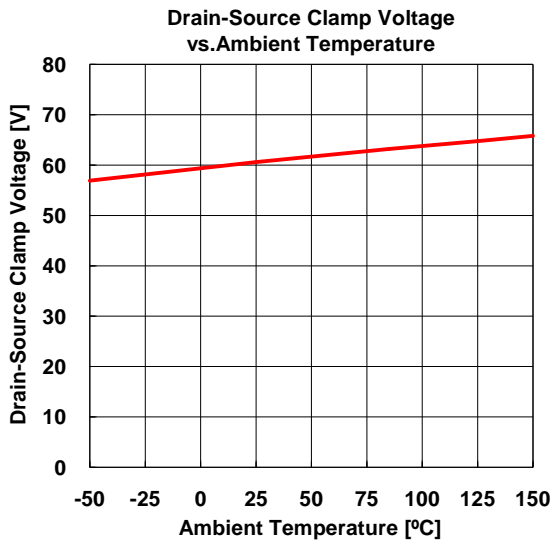
NJW4832

■ TYPICAL APPLICATION

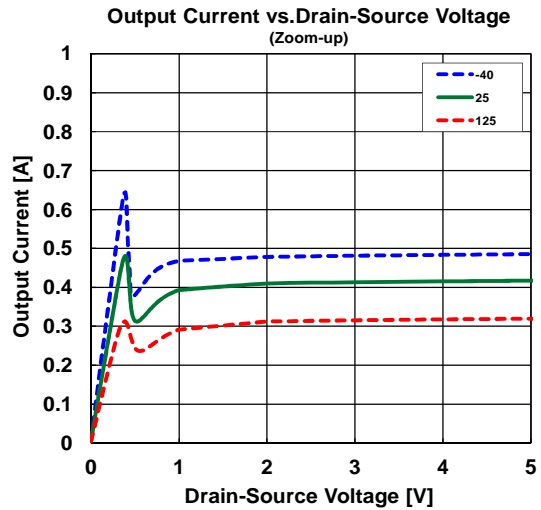
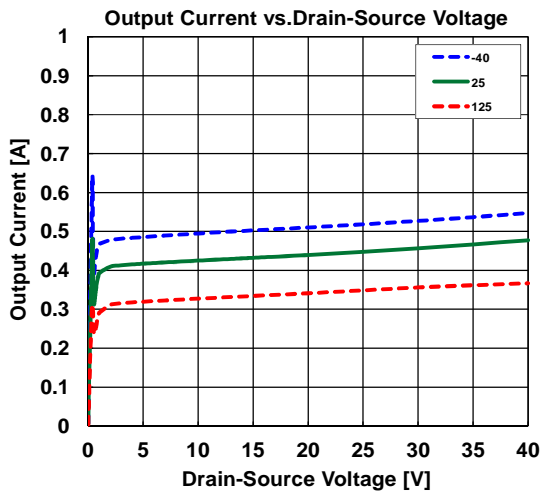
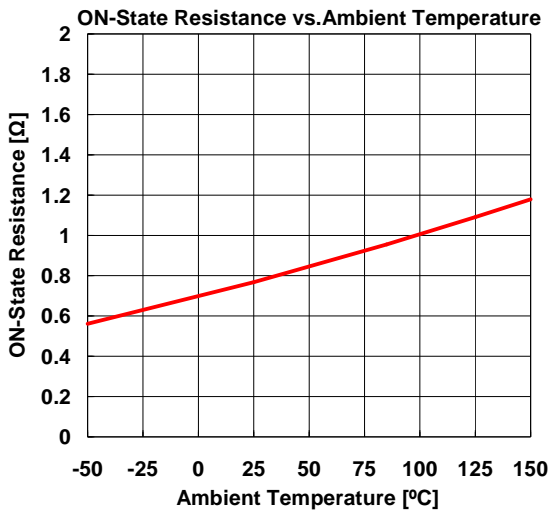
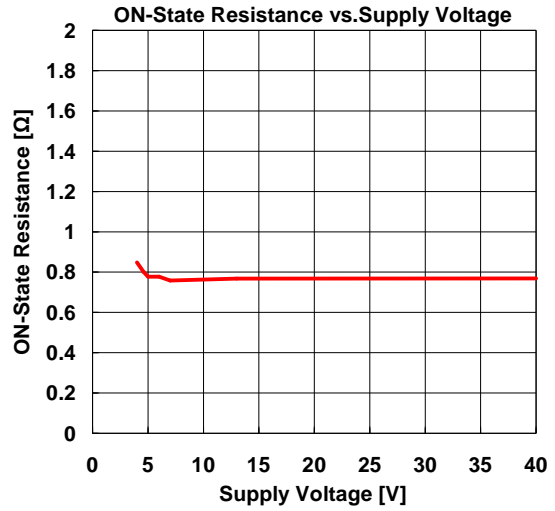
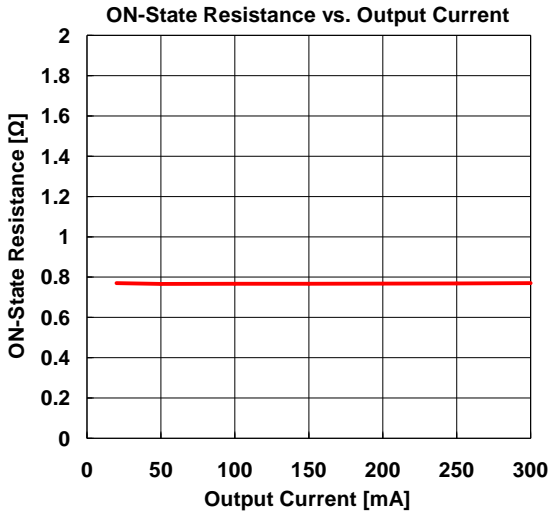


You should insert a pull-up resistor when you connect the FLT pin with other power supplies etc.

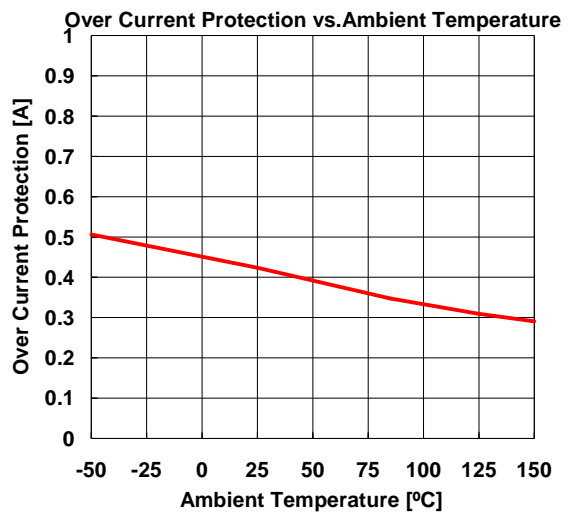
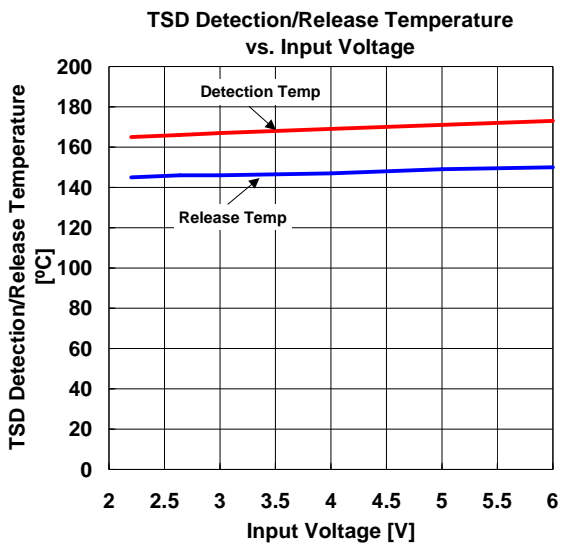
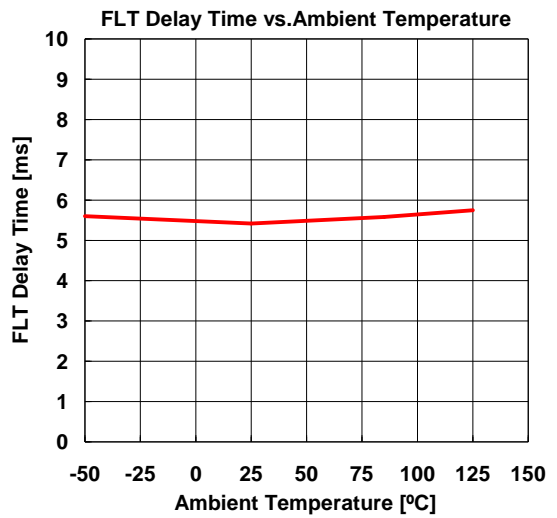
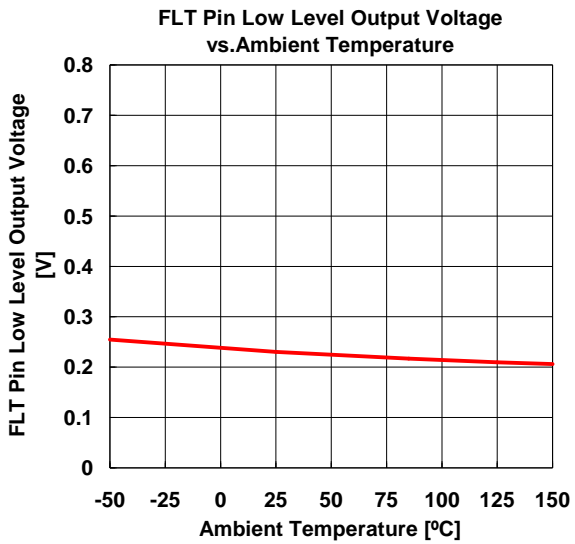
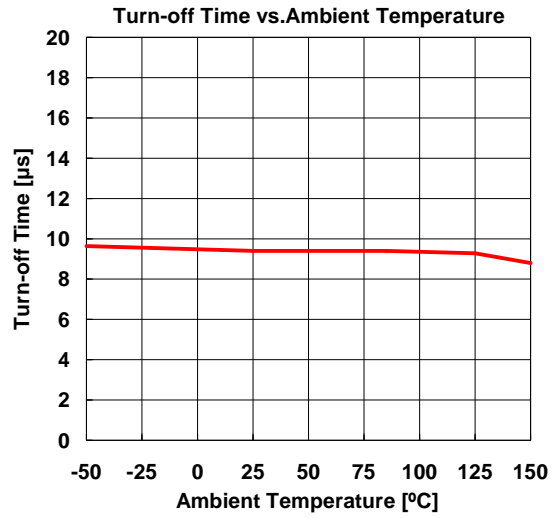
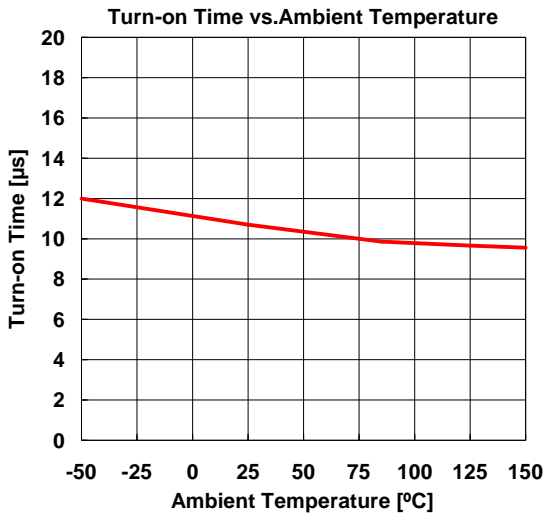
■ CHARACTERISTICS



CHARACTERISTICS



CHARACTERISTICS



■ Regarding Active Clamp Capacity of High/Low side Switch Products

- What is “Active Clamp Capacity”.

The IC might suffer to damage by the inductive kickback at the transient time of ON state to OFF state, when an inductive load such as a solenoid or motor is used for the load of the high-side/low-side switch.

The protection circuit for the inductive kickback is the active clamp circuit. The energy that can be tolerated by the active clamp circuit is called "Active Clamp Capacity (E_{AS})".

When using an inductive load to the high-side/low-side switch, you should design so that the E_{SW} does not exceed the active clamp capability.

- IC operation without an external protection parts (Fig 1)

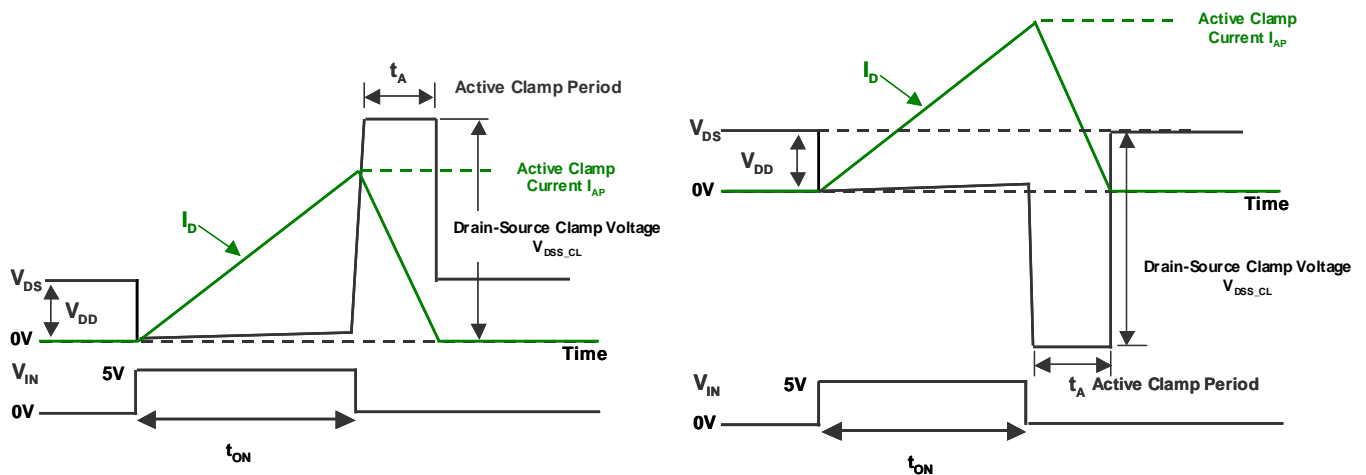


Fig1. Active Clamp Waveform (Left: Low-side Switch / Light High-side Switch)

At when the V_{IN} turns off, the drain-source voltage (V_{DS}) increases rapidly by the behavior of the inductive load that is keeping current flowing. However, it will be clamped at V_{DSS_CL} by the active clamp circuit. At the same time, the drain current is flowed by adjusting the gate voltage of the output transistor, and the energy is dissipated at the output transistor. The energy: E_{SW} is shown by the following formula.

$$E_{SW} = \int_0^{t_A} V_{DS}(t) \cdot I_D(t) dt = \frac{1}{2} L I_{AP}^2 \cdot \frac{V_{DSS_CL}}{V_{DSS_CL} - V_{DD}}$$

The E_{SW} is consumed inside IC as heat energy. However, the thermal shutdown does not work when the V_{IN} is 0V. Therefore in worst case the IC might break down. When using the active clamp, you should design E_{SW} does not exceed the E_{AS} .

- Application Hint

The simplest protection example is to add an external flywheel diode at the load to protect IC from an inductive kickback. (Fig.2)

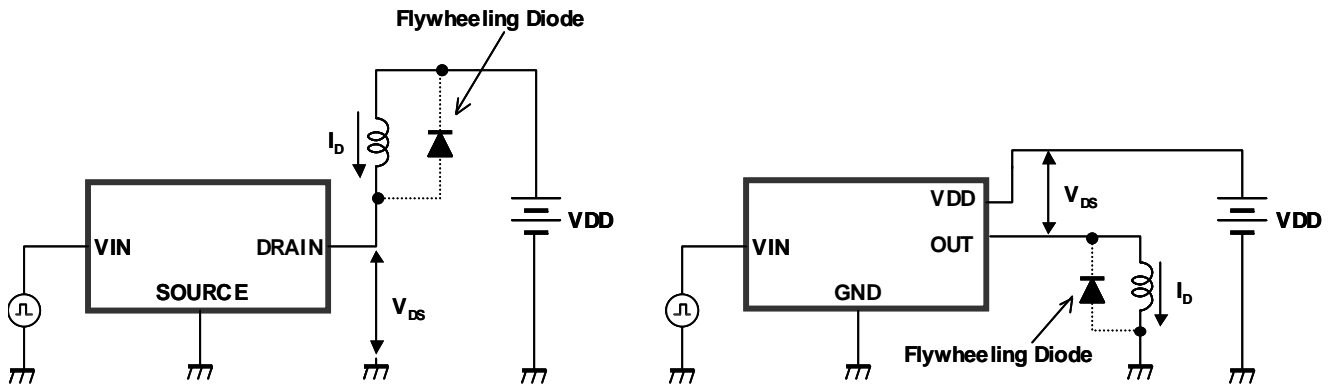


Fig 2. Application Circuit of Inductance Load Driving (Left: Low-side Switch / Light High-side Switch)

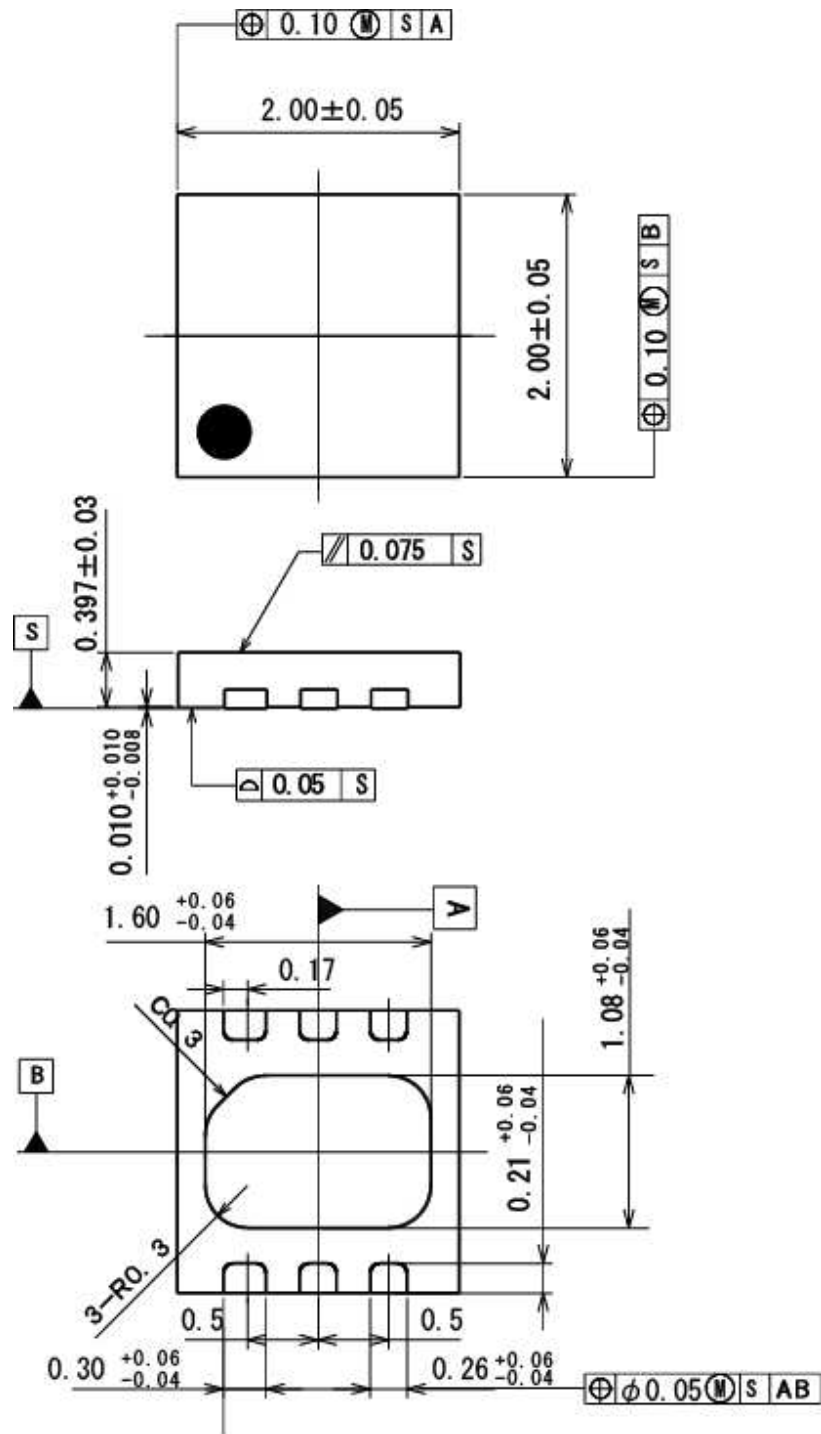
[CAUTION]

The specifications on this databook are only given for information, without any guarantee as regards either mistakes or omissions. The application circuits in this databook are described only to show representative usages of the product and not intended for the guarantee or permission of any right including the industrial rights.

NJW4832

■ PACKAGE OUT LINE

■ DFN6-H1 (ESON6-H1)



GD-N00602A-0
UNIT: mm

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[NJR:](#)

[NJW4832KH1-A-TE3](#) [NJW4832KH1-B-TE3](#)

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9